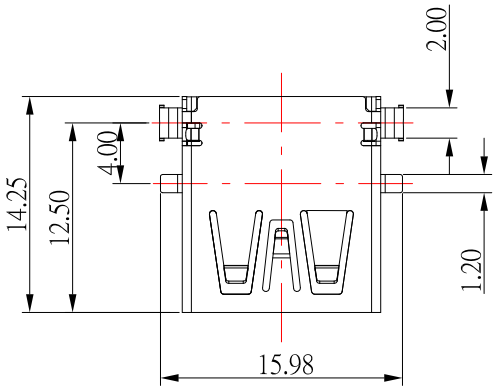
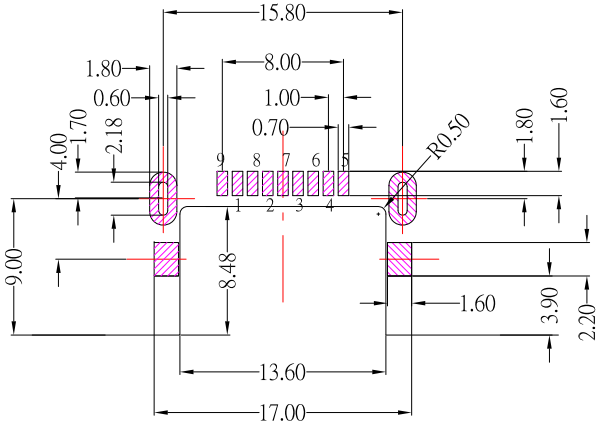
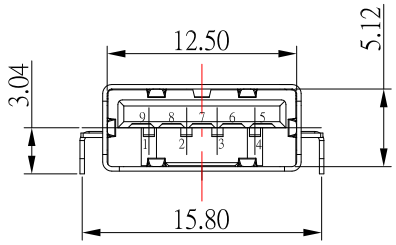


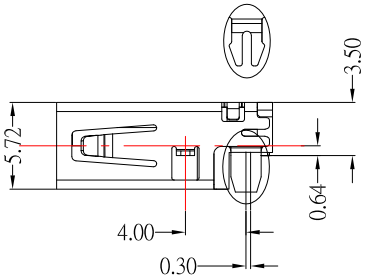


SUA-110M1A-30x-S277

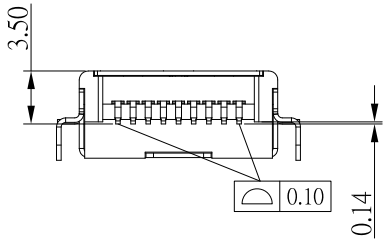
鍍層厚度 :

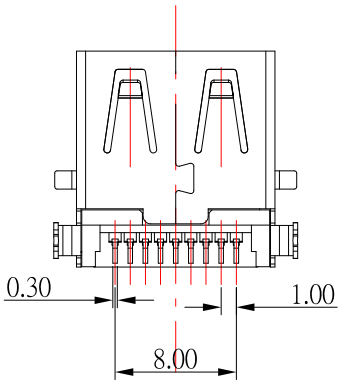
Blank : 1u"
2 : 15u"
3 : 30u"

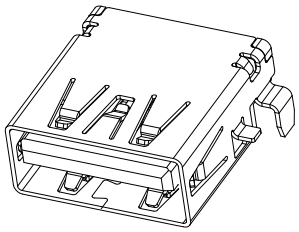




RECOMMANDED PCBA LAYOUT







SPECIFICATIONS:

1.ELECTRICAL CHARACTERISTICS;
- 1.1 CONTACT RESISTANCE: 30mΩ MAX
- 1.2 DIELECTRIC WITHSTANDING VOLTAGE: 100 V 1 min
- 1.3 INSULATION RESISTANCE: 100 MΩ MIN
- 1.4 OPERATING TEMPEROTURE: -25˚C ～ 85˚C

2.MATERIAL:
- 2.1 HOUSING: LCP , Color:Blue
- 2.2 CONTACT: PHOSPHOR BRONZE
- 2.3 SHELL: BRASS

3.PLATING:
- 3.1 CONTACT: PLATED GOLD IN MATING AREA ;
  TIN PLATED ON SOLDER BALLS ;
  NICKEL UNDER PLATED OVERALL
- 3.2 SHELL: NICKEL UNDER PLATED SURFACE LAYER

ITEM NO.	DESCRIPTION	DRAWN	DATE
1	新增膠芯顏色	Jack	010522

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3˚

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 01/05/22	MAT'L	
CHECKED BY: Jacky Chen	DATE 01/05/22	FINISH	
APPROVED BY: Tony Kao	DATE 01/05/22	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	USB 3.0 AF SMT 沉板3.5mm 無捲邊		
DWG NO.	SUA-110M1A-30x-S277	SIZE	A4
PART NO.	SUA-110M1A-30x-S277	VER	R1